



# VIS30728

## 30V N-Channel SGT MOSFET

### General Description

- SGT MOSFET Technology
- Low  $R_{DS(ON)}$  at 4.5V  $V_{GS}$
- Low Gate Charge
- High Current Capability
- RoHS and Halogen-Free Compliant

### Applications

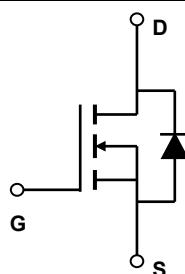
- General DC/DC Converters
- VRM Vcore for Notebook and Server
- Battery Power Management
- Motor Drive Bridge Switch

### Product Summary

$V_{DS}$	30V
$I_D$ (at $V_{GS}=10V$ )	90A
$R_{DS(ON)}$ (at $V_{GS}=10V$ , typ)	2.3mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$ , typ)	3.6mΩ

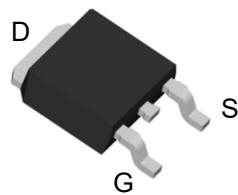
100% UIS Tested

100%  $R_g$  Tested

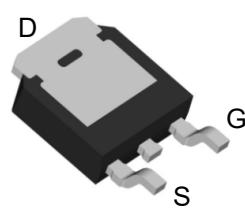


Top View

TO-252



Bottom View



Orderable Part Number	Package Type	Form	Minimum Order Quantity
VIS30728	TO-252	Tape & Reel	2500

### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current (5)	$I_D$	90	A
		TBD	A
Pulsed Drain Current (3)	$I_{DM}$	TBD	A
Continuous Drain Current	$I_{DSM}$	TBD	A
		TBD	A
Avalanche Current (3)	$I_{AS}$	33	A
Avalanche Energy L=0.1mH (3)	$E_{AS}$	54	mJ
Power Dissipation (2)	$P_D$	TBD	W
		TBD	W
Power Dissipation (1)	$P_{DSM}$	TBD	W
		TBD	W
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient (1)	$R_{\theta JA}$	16		°C/W
Maximum Junction-to-Ambient (1,4)		41		°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.9		°C/W



# VIS30728

## 30V N-Channel SGT MOSFET

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$		1		$\mu\text{A}$
		$T_J=55^\circ\text{C}$		5		
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.4	1.8	2.2	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$		2.3	2.8	$\text{m}\Omega$
		$T_J=125^\circ$		TBD		
		$V_{GS}=4.5\text{V}, I_D=20\text{A}$		3.6	4.7	
$g_{FS}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$				S
$V_{SD}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.7		V
$I_S$	Maximum Body-Diode Continuous Current				TBD	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		2600		pF
$C_{oss}$	Output Capacitance			988		pF
$C_{rss}$	Reverse Transfer Capacitance			80		pF
$R_g$	Gate resistance	$f=1\text{MHz}$		1.5		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=20\text{A}$		34		nC
$Q_g(4.5\text{V})$	Total Gate Charge			17		nC
$Q_{gs}$	Gate Source Charge			TBD		nC
$Q_{gd}$	Gate Drain Charge			TBD		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=0.75\Omega, R_{\text{GEN}}=3\Omega$		TBD		ns
$t_r$	Turn-On Rise Time			TBD		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			TBD		ns
$t_f$	Turn-Off Fall Time			TBD		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=20\text{A}, di/dt=200\text{A}/\mu\text{s}$		TBD		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, di/dt=200\text{A}/\mu\text{s}$		40		nC
<p>1) <math>R_{\text{BJA}}</math> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with <math>T_A = 25^\circ\text{C}</math>. The Power dissipation <math>P_{\text{DSM}}</math> is based on <math>R_{\text{BJA}} \leq 10\text{s}</math> and the maximum allowed junction temperature of <math>150^\circ\text{C}</math>. The value in any given application depends on the user's specific board design.</p> <p>2) The power dissipation <math>P_D</math> is based on <math>T_{J(\text{MAX})}=150^\circ\text{C}</math>, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.</p> <p>3) Single pulse width limited by junction temperature <math>T_{J(\text{MAX})}=150^\circ\text{C}</math>.</p> <p>4) <math>R_{\text{BJA}}</math> is the sum of the thermal impedance from junction to case <math>R_{\text{BJC}}</math> and case to ambient.</p> <p>5) The maximum current rating is package limited.</p>						

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